Qualcomm

RF360
Europe GmbH

SAW components

SAW duplexer
WCDMA / LTE band 8

Series/type:	B8664
Ordering code:	B39941B8664P810
Date:	May 11, 2018
Version:	2.1

DCN: 80-PA243-8 Rev. A

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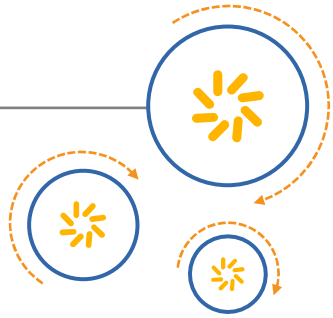
RF360 Europe GmbH, Anzinger Str. 13, München, Germany

RF360 Europe GmbH

A Qualcomm – TDK Joint Venture



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SAW components **B8664**

SAW duplexer **897.5 / 942.5 MHz**

Data sheet

SAW components **B8664**

SAW duplexer **897.5 / 942.5 MHz**

Data sheet

Table of contents

1 Application

- Low-loss SAW duplexer for mobile telephone LTE and WCDMA Band 8 system
- Low insertion attenuation
- Low amplitude ripple
- Usable pass band 35 MHz
- Single-ended duplexer
- High isolation between Tx and Rx

2 Features

- Package size 1.8±0.1 mm × 1.4±0.1 mm
- Package height 0.475 mm (max.)
- Approximate weight 4 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

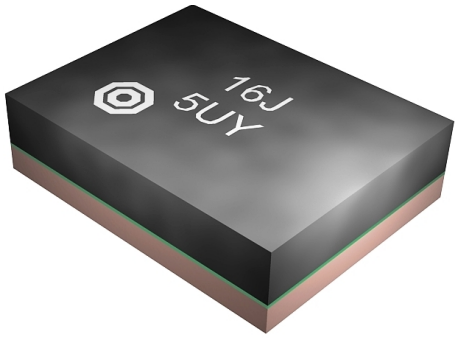

Figure 1: Picture of component with example of product marking.

3 Package

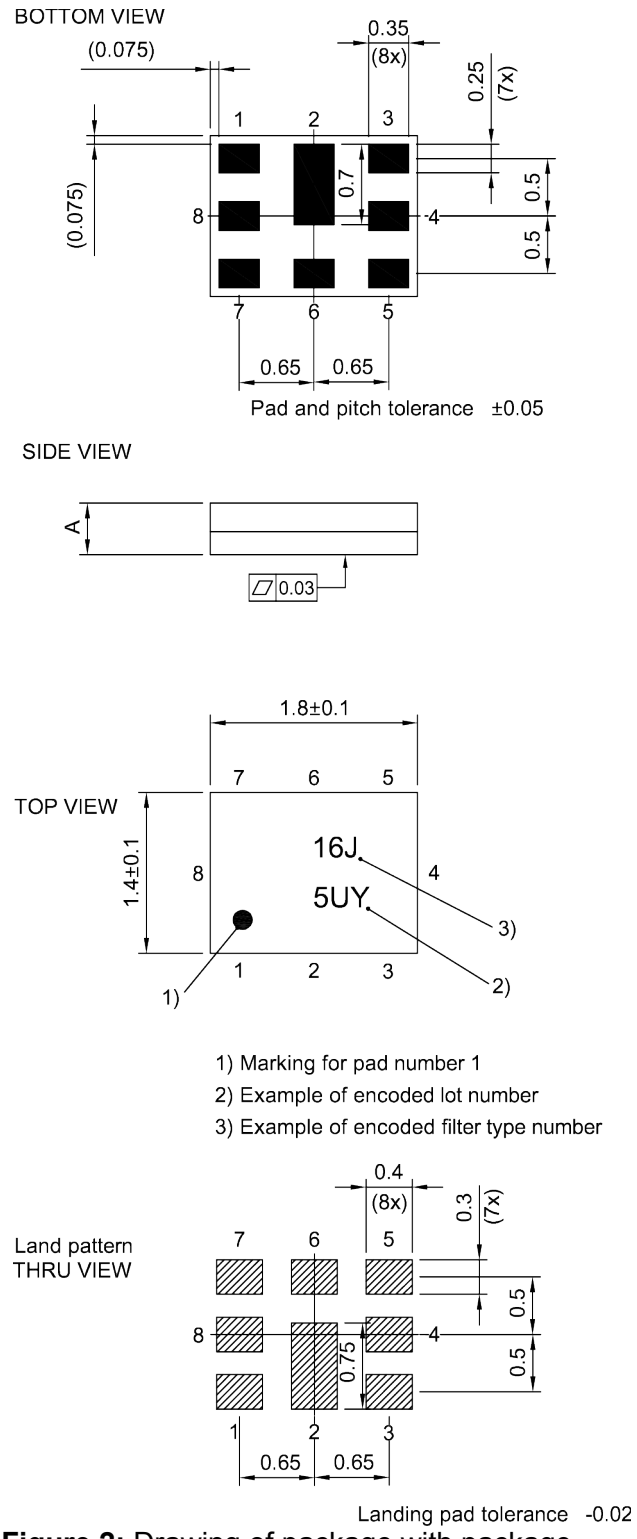

Figure 2: Drawing of package with package height A = 0.475 mm (max.). See Sec. Package information (p. 23).

4 Pin configuration

- 1 RX
- 3 TX
- 6 ANT
- 2, 4, 5, 7, 8 Ground

5 Matching circuit

- L_{p6} = 8.2 nH
- L_{s3} = 1.5 nH
- L_{s1} = 1.0 nH

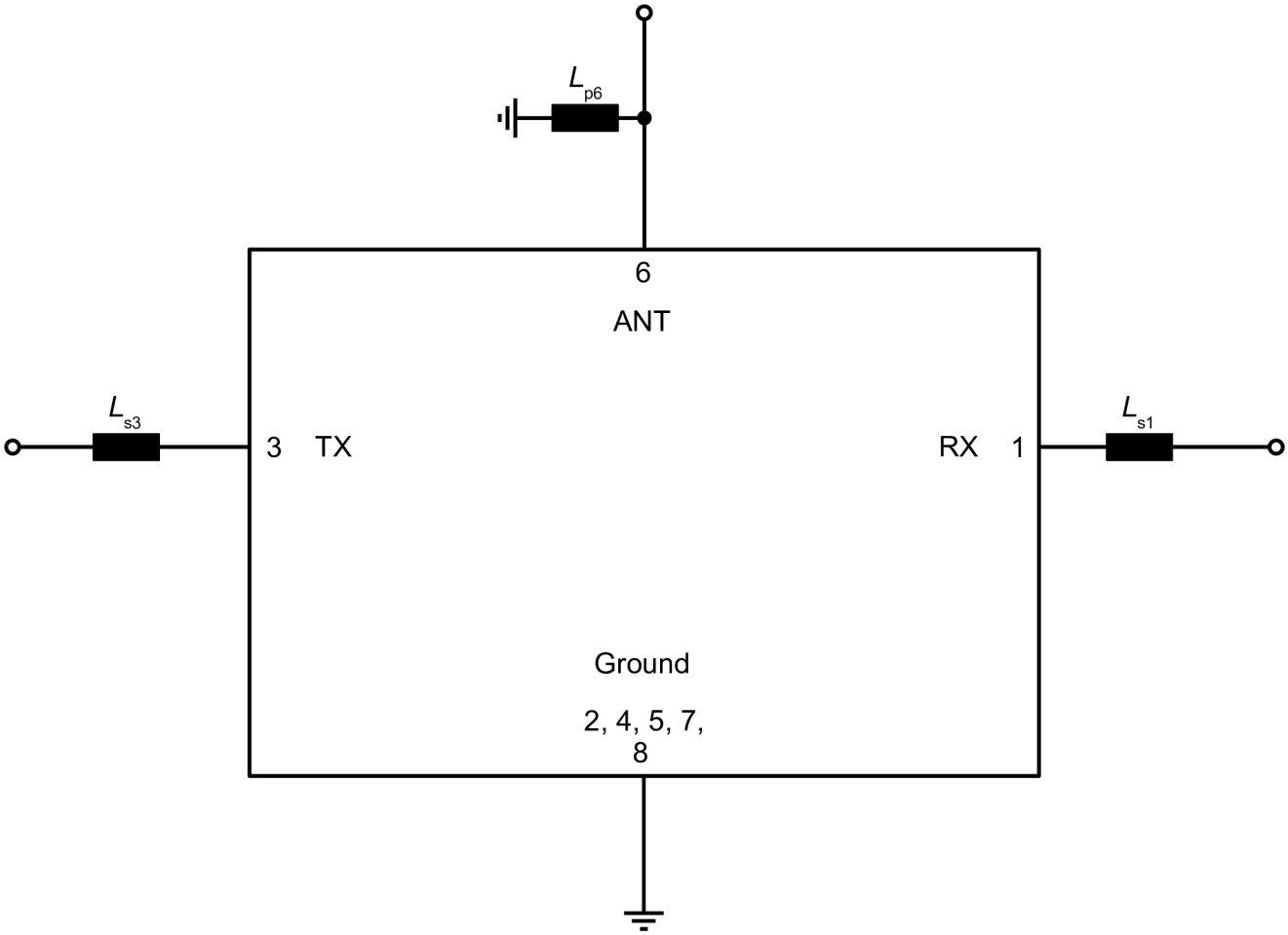

Figure 3: Schematic of matching circuit.

External shunt inductor for ESD protection is recommended at any ports towards antenna.

6 Characteristics

6.1 TX – ANT

Temperature range for specification T_{SPEC} = −20 °C ... +90 °C
TX terminating impedance Z_{TX} = 50 Ω with ser. 1.5 nH[1)]
ANT terminating impedance Z_{ANT} = 50 Ω with par. 8.2 nH[1)]
RX terminating impedance Z_{RX} = 50 Ω with ser. 1.0 nH[1)]

Characteristics TX – ANT					min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency				f_C	—	897.5	—	MHz
Maximum insertion attenuation								
	880.24 ... 914.76	MHz		α_{max}	—	1.7	2.8[2)]	dB
	880.24 ... 914.76	MHz		α_{max}	—	1.7	3.0	dB
@$f_{carrier}$	882.4 ... 912.6	MHz		$\alpha_{WCDMA,max}$[3)]	—	1.3	2.5	dB
Amplitude ripple (p-p)				$\Delta\alpha$				
	880.24 ... 914.76	MHz			—	0.9	2.0	dB
Maximum VSWR				$VSWR_{max}$				
@ TX port	880 ... 915	MHz			—	1.5	2.0	
@ ANT port	880 ... 915	MHz			—	1.5	2.0	
Minimum attenuation								
	10 ... 716	MHz		α_{min}	30	42	—	dB
	716 ... 728	MHz		α_{min}	35	42	—	dB
	728 ... 821	MHz		α_{min}	30	42	—	dB
	832 ... 862	MHz		α_{min}	30	42	—	dB
	925.24 ... 959.76	MHz		α_{min}	45	55	—	dB
@$f_{carrier}$	927.4 ... 957.6	MHz		$\alpha_{WCDMA,min}$[3)]	45	59	—	dB
	1559 ... 1563	MHz		α_{min}	40	45	—	dB
	1565.42 ... 1585.42	MHz		α_{min}	40	43	—	dB
	1597.55 ... 1605.89	MHz		α_{min}	40	43	—	dB
	1710 ... 1785	MHz		α_{min}	30	42	—	dB
	1760 ... 1840	MHz		α_{min}	38	41	—	dB
	1840 ... 1880	MHz		α_{min}	38	41	—	dB
	2110 ... 2170	MHz		α_{min}	27	39	—	dB
	2400 ... 2500	MHz		α_{min}	35	38	—	dB
	2620 ... 2745	MHz		α_{min}	32	37	—	dB
	3520 ... 3660	MHz		α_{min}	20	35	—	dB
	4400 ... 4575	MHz		α_{min}	20	38	—	dB
	4900 ... 5950	MHz		α_{min}	15	20	—	dB

1) See Sec. Matching circuit (p. 6).
2) Valid for temperature T = +25 °C...+90 °C.
3) Attenuation of WCDMA signal ("power transfer function"). Please refer to definition of Power Transfer Function (PTF) of

6.2 ANT – RX

Temperature range for specification	T_{SPEC}	= −20 °C ... +90 °C
TX terminating impedance	Z_{TX}	= 50 Ω with ser. 1.5 nH[1)]
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 8.2 nH[1)]
RX terminating impedance	Z_{RX}	= 50 Ω with ser. 1.0 nH[1)]

Characteristics ANT – RX					**min.** for T_{SPEC}	**typ.** @ +25 °C	**max.** for T_{SPEC}	
Center frequency				f_C	—	942.5	—	MHz
Maximum insertion attenuation								
	925.24 ... 959.76		MHz	α_{max}	—	2.0	3.0	dB
@$f_{carrier}$	927.4 ... 957.6		MHz	$\alpha_{WCDMA,max}$ [2)]	—	1.7	3.0	dB
Amplitude ripple (p-p)				$\Delta\alpha$				
	925.24 ... 959.76		MHz		—	0.9	2.0	dB
Maximum VSWR				$VSWR_{max}$				
@ ANT port	925 ... 960		MHz		—	1.7	2.0	
@ RX port	925 ... 960		MHz		—	1.7	2.0	
Minimum attenuation				α_{min}				
	10 ... 880		MHz		45	60	—	dB
	880.24 ... 914.76		MHz		45	57	—	dB
	1045 ... 4625		MHz		40	48	—	dB
	4625 ... 6000		MHz		30	35	—	dB

1) See Sec. Matching circuit (p. 6).
2) Attenuation of WCDMA signal ("power transfer function"). Please refer to definition of Power Transfer Function (PTF) of WCDMA signal (p. 22).

6.3 TX – RX

Temperature range for specification	T_{SPEC}	= −20 °C ... +90 °C
TX terminating impedance	Z_{TX}	= 50 Ω with ser. 1.5 nH[1)]
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 8.2 nH[1)]
RX terminating impedance	Z_{RX}	= 50 Ω with ser. 1.0 nH[1)]

Characteristics TX – RX					min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Minimum isolation								
	880.24 ... 914.76	MHz	α_{min}		55	57	—	dB
@$f_{carrier}$	882.4 ... 912.6	MHz	$\alpha_{WCDMA,min}$	2)	55	59	—	dB
	925.24 ... 959.76	MHz	α_{min}		55[3)]	60	—	dB
	925.24 ... 959.76	MHz	α_{min}		50	60	—	dB
@$f_{carrier}$	927.4 ... 957.6	MHz	$\alpha_{WCDMA,min}$	2)	55	61	—	dB

1) See Sec. Matching circuit (p. 6).
2) Attenuation of WCDMA signal ("power transfer function"). Please refer to definition of Power Transfer Function (PTF) of WCDMA signal (p. 22).
3) Valid for temperature T = +20 °C...+90 °C.

7 Maximum ratings

Storage temperature	T_{STG} [1] = −40 °C ... +90 °C	
DC voltage	$\lvert V_{DC} \rvert$ [2] = 0 V (max.)	
ESD voltage		
	V_{ESD} [3] = 100 V (max.)	Machine model.
	V_{ESD} [4] = 100 V (max.)	Human body model.
	V_{ESD} [5] = 500 V (max.)	Charged device model.
Input power @ TX port: 880 ... 915 MHz	P_{IN} = 29 dBm	5 MHz LTE uplink signal (25 RB) for 5000 h @ 50 °C.

1) Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.
2) In case of applied DC voltage blocking capacitors are mandatory.
3) According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.
4) According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.
5) According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.

8 Transmission coefficients

8.1 TX – ANT

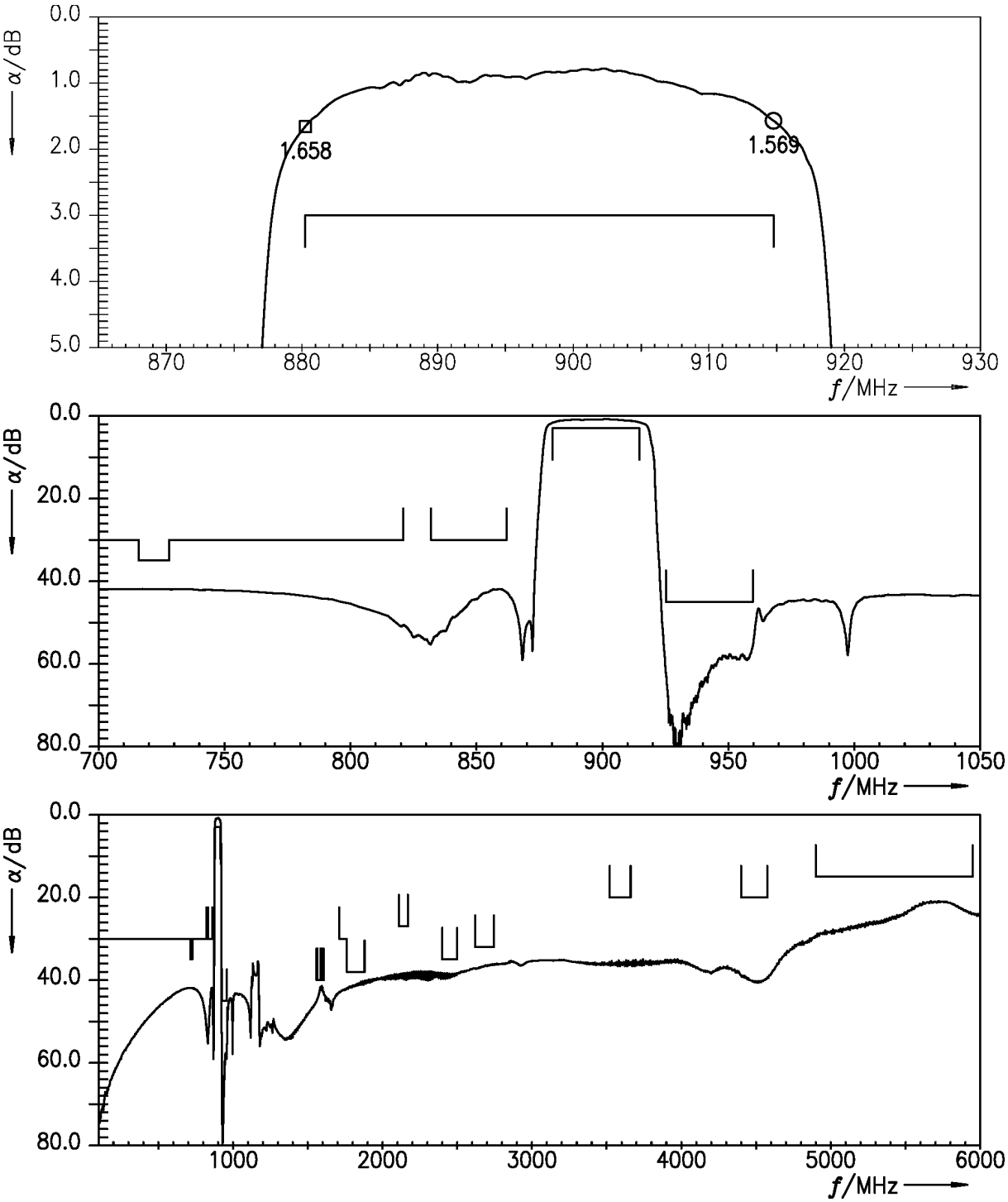

Figure 4: Attenuation TX – ANT.

8.2 ANT – RX

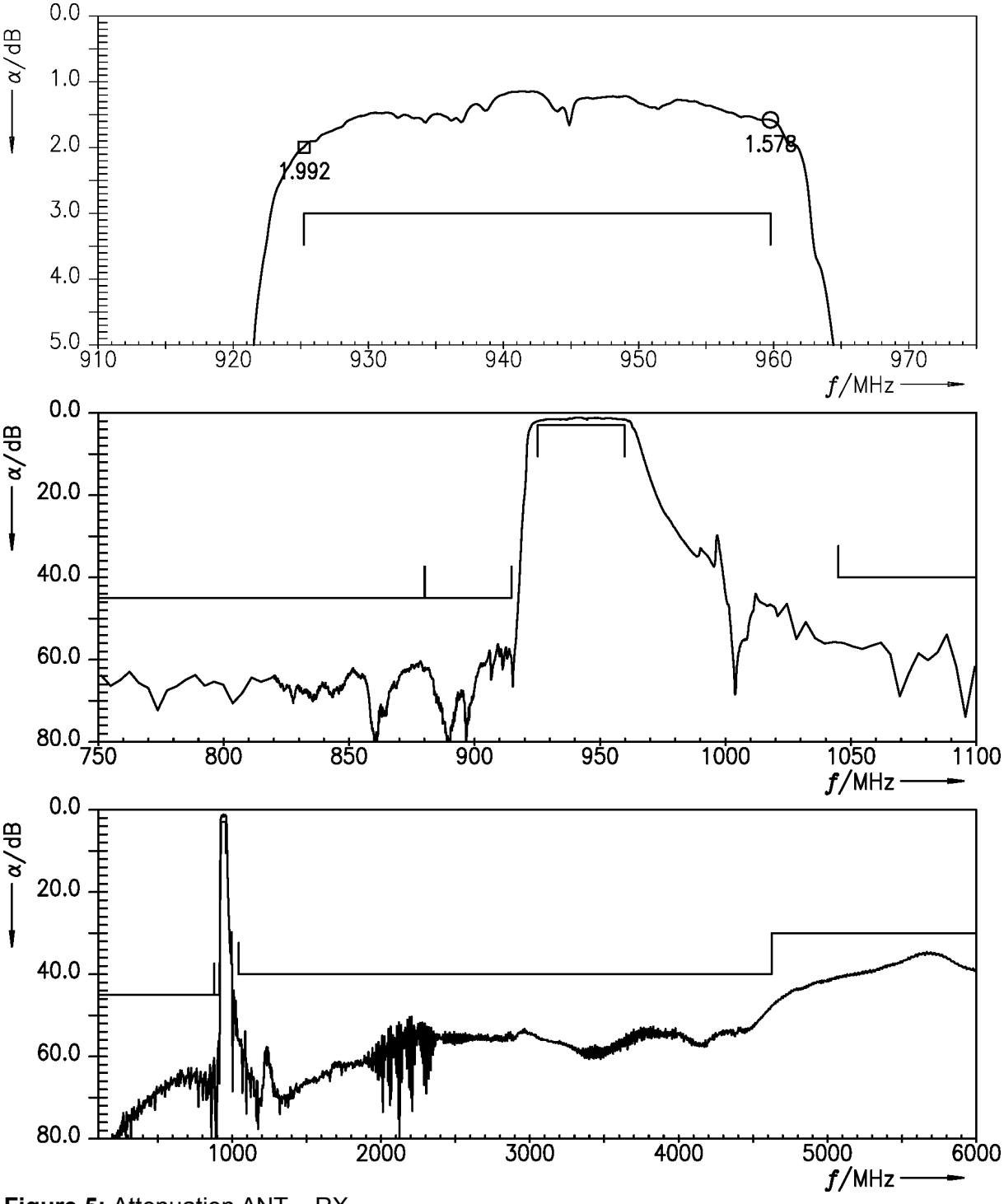

Figure 5: Attenuation ANT – RX.

8.3 TX – RX

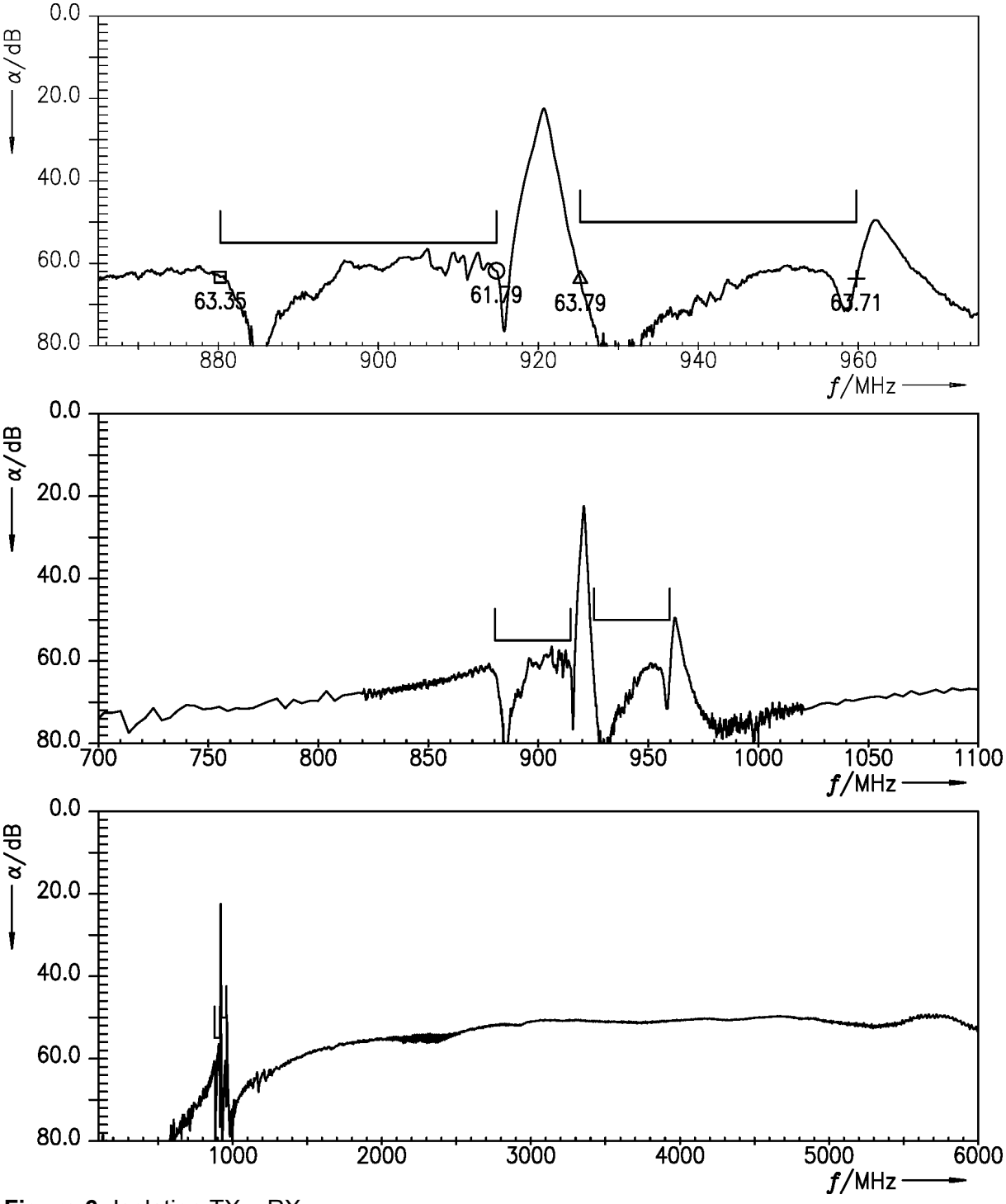

Figure 6: Isolation TX – RX.

9 Reflection coefficients

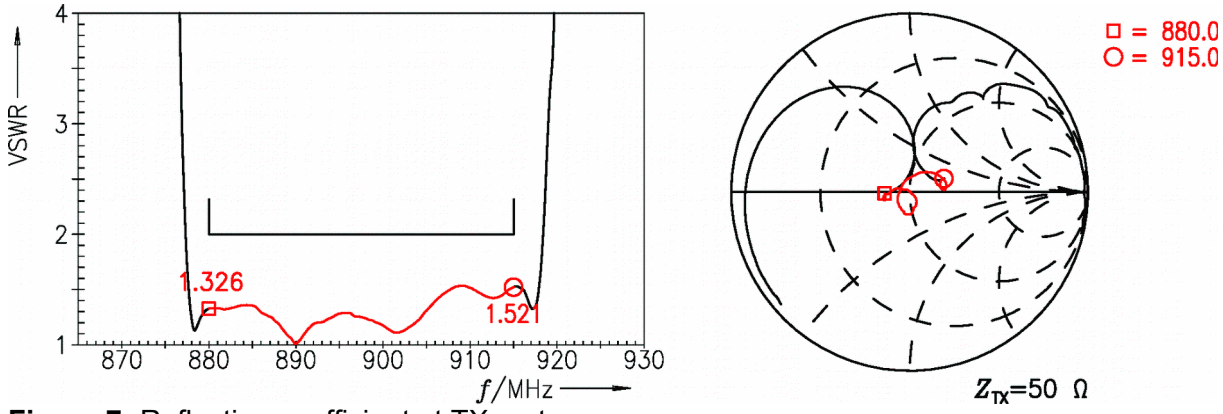

Figure 7: Reflection coefficient at TX port.

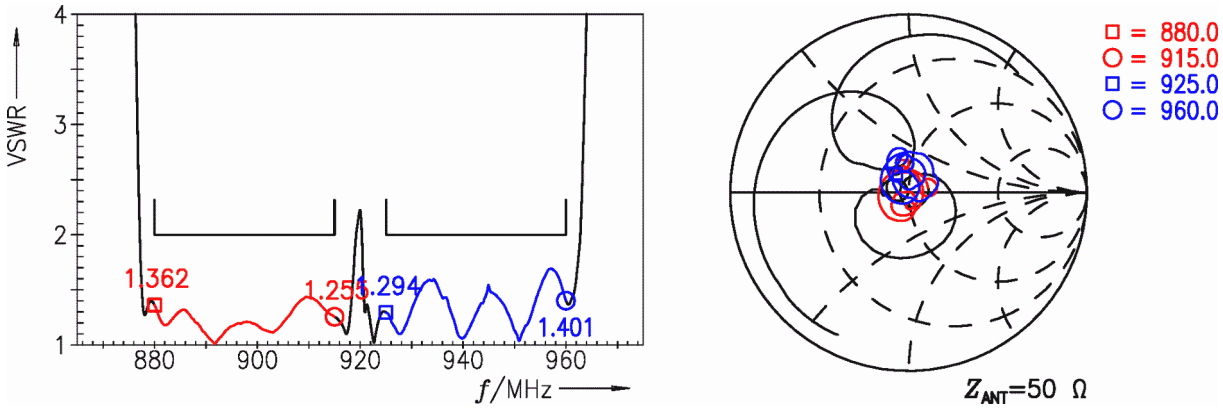

Figure 8: Reflection coefficient at ANT port.

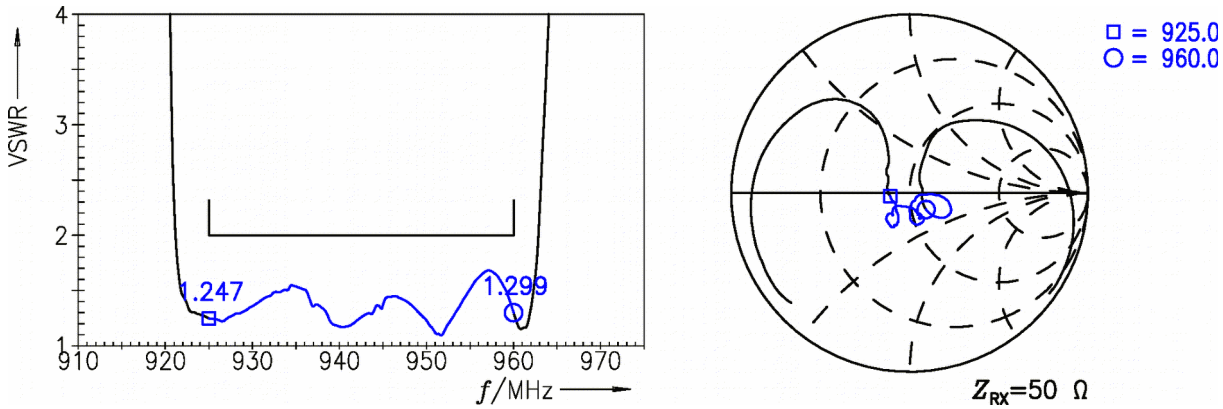

Figure 9: Reflection coefficient at RX port.

10 Packing material

10.1 Tape

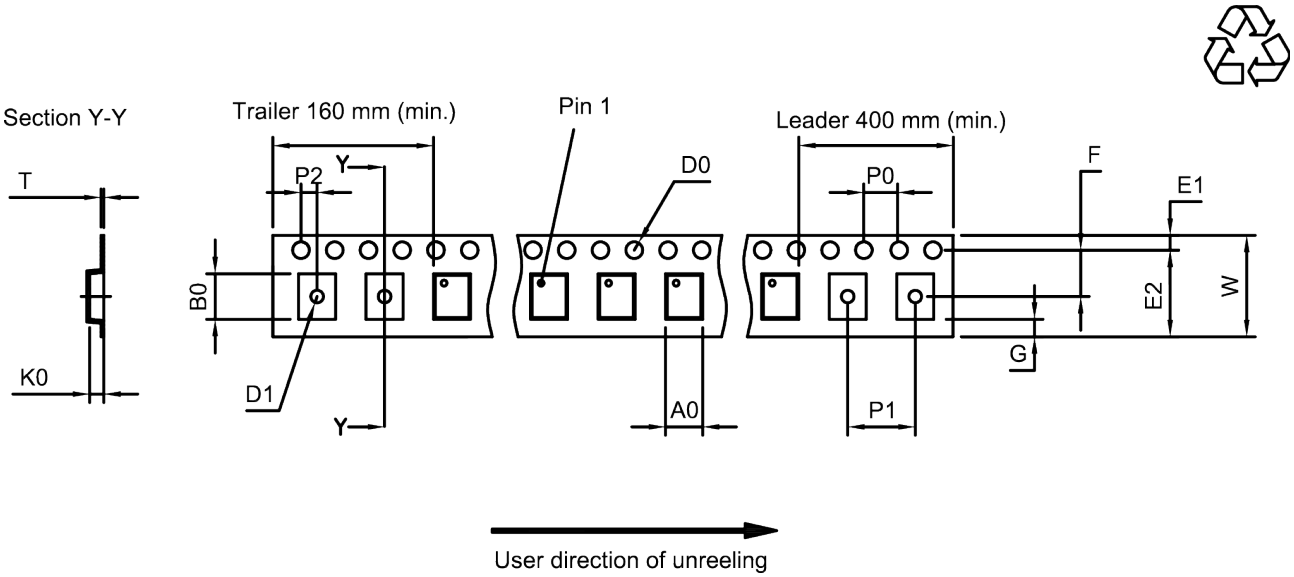

Figure 10: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A_0	$1.62_{\pm 0.05}$ mm
B_0	$2.04_{\pm 0.05}$ mm
D_0	$1.5^{+0.1/-0}$ mm
D_1	$0.8_{\pm 0.05}$ mm
E_1	$1.75_{\pm 0.1}$ mm

E_2	6.25 mm (min.)
F	$3.5_{\pm 0.05}$ mm
G	0.75 mm (min.)
K_0	$0.62_{\pm 0.05}$ mm
P_0	$4.0_{\pm 0.1}$ mm

P_1	$4.0_{\pm 0.1}$ mm
P_2	$2.0_{\pm 0.05}$ mm
T	$0.25_{\pm 0.05}$ mm
W	$8.0_{\pm 0.1}$ mm

Table 1: Tape dimensions.

10.2 Reel with diameter of 180 mm

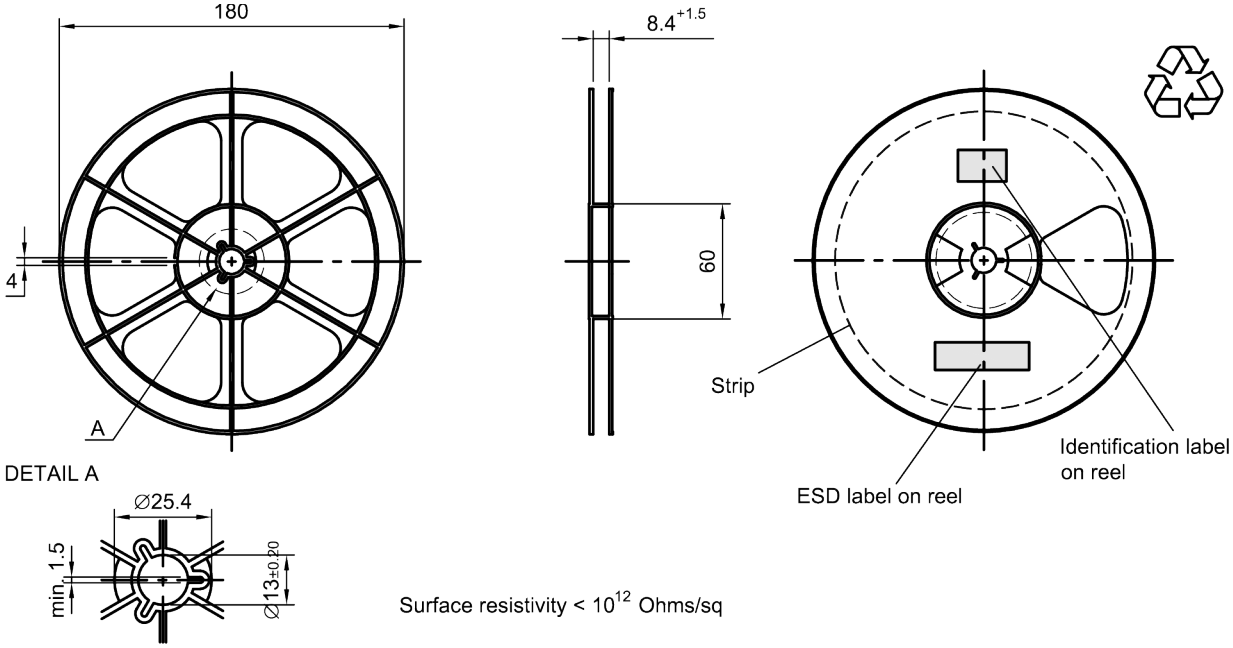

Figure 11: Drawing of reel (first-angle projection) with diameter of 180 mm.

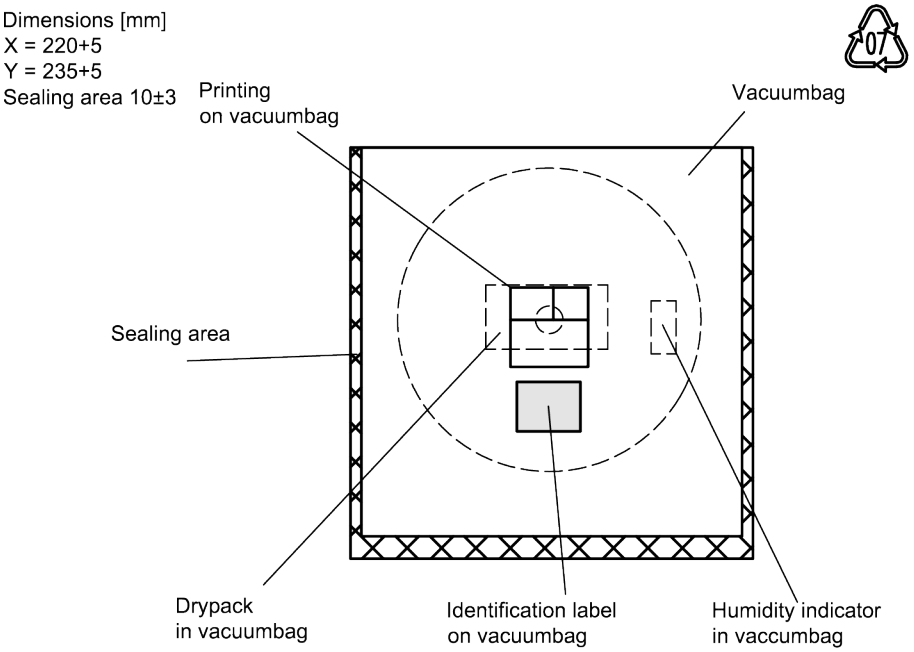

Figure 12: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

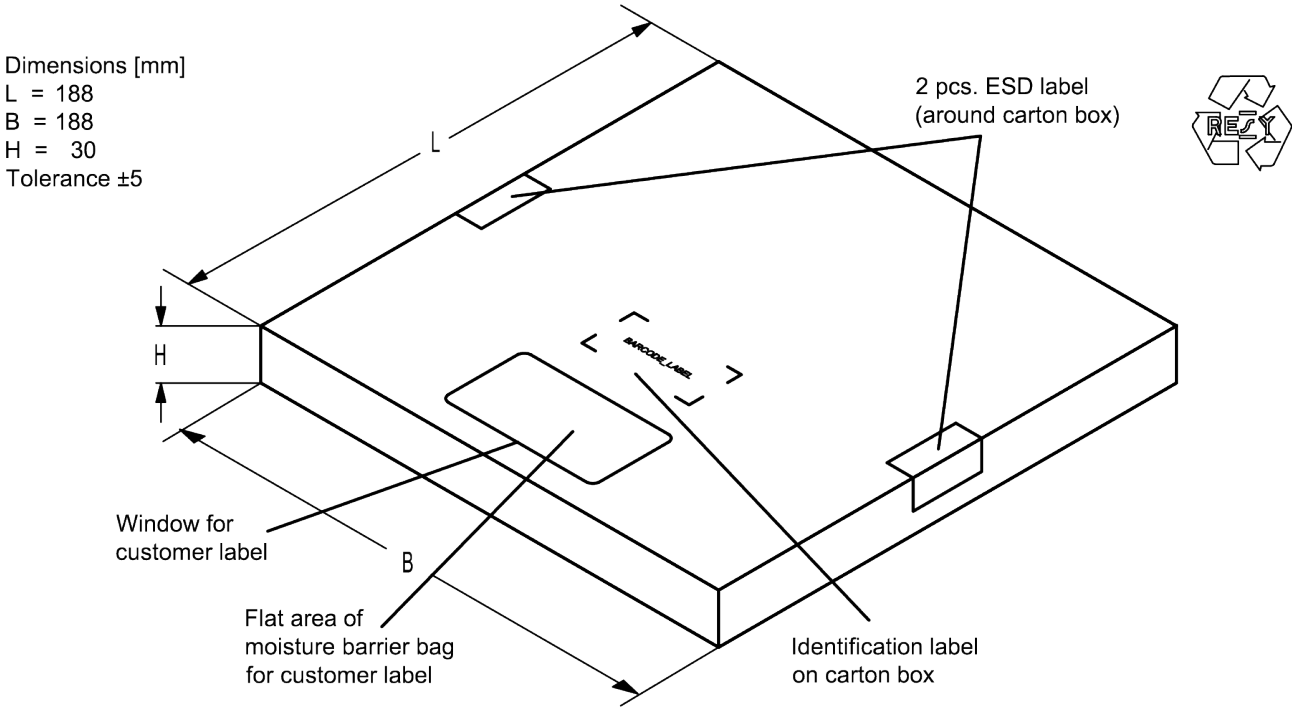

Figure 13: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm

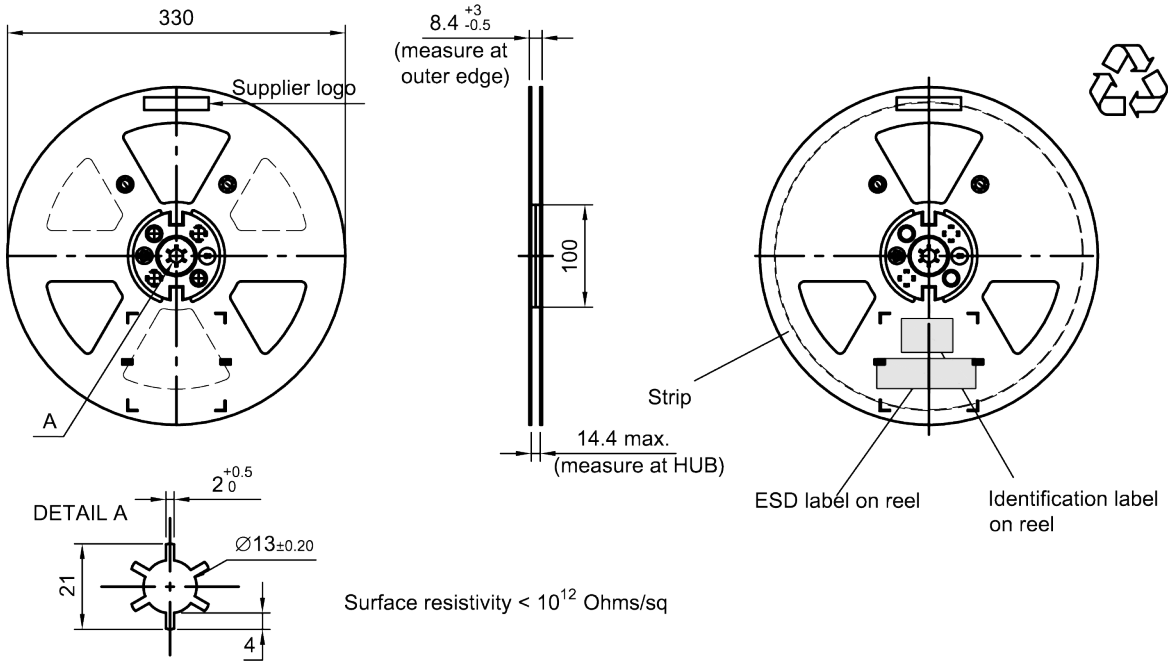

Figure 14: Drawing of reel (first-angle projection) with diameter of 330 mm.

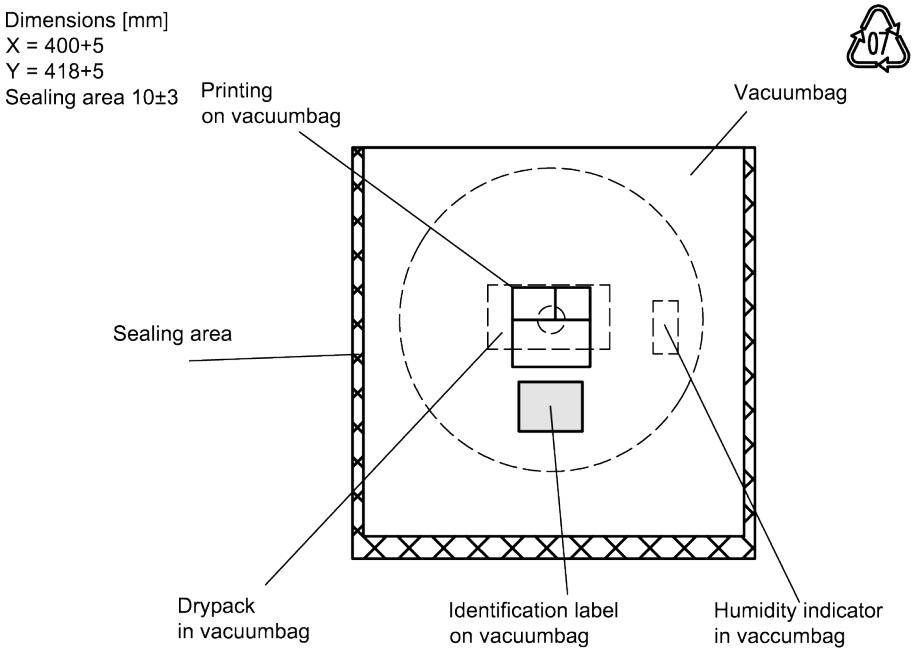

Figure 15: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

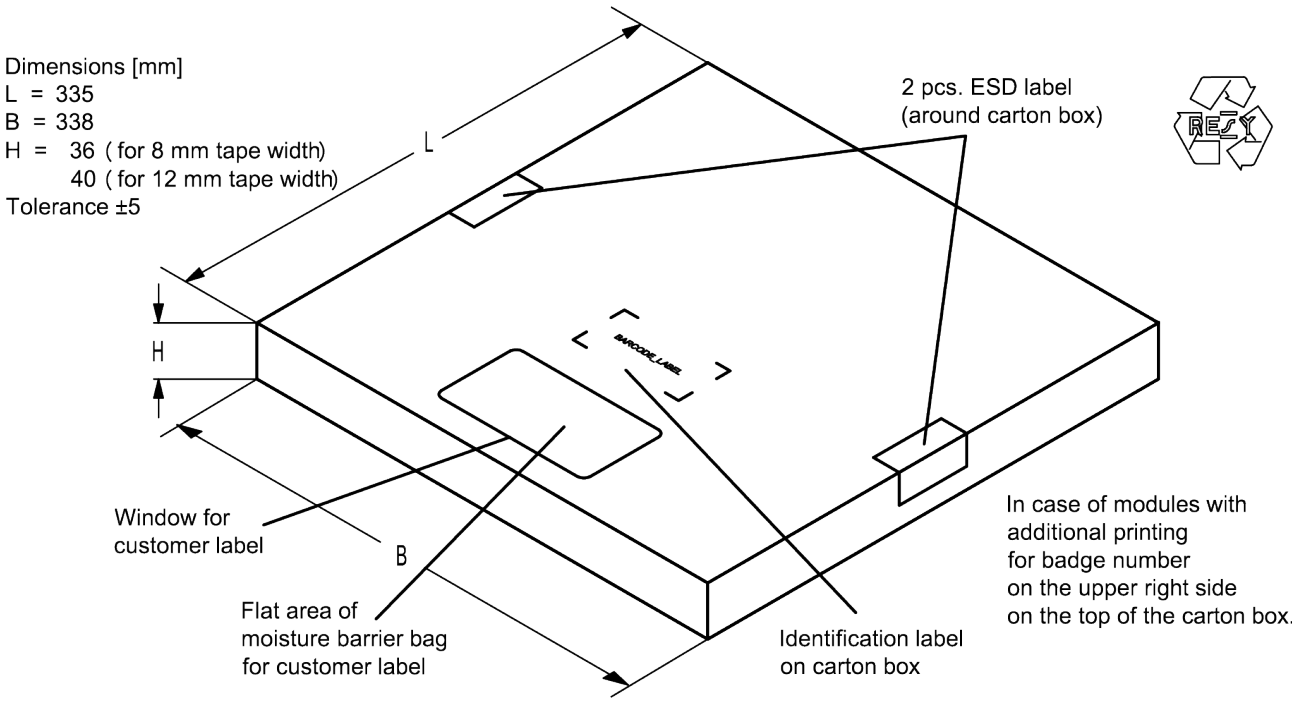

Figure 16: Drawing of folding box for reel with diameter of 330 mm.

11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

- Type number:

  The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,
  is encoded by a special BASE32 code into a 3 digit marking.

  Example of decoding type number marking on device in decimal code.
  16J **=>** **1234**
  1 x 32^2 + **6** x 32^1 + **18 (=J)** x 32^0 **=** **1234**
  The BASE32 code for product type B8664 is 8ER.

- Lot number:

  The last 5 digits of the lot number, e.g., **12345**,
  are encoded based on a special BASE47 code into a 3 digit marking.

  Example of decoding lot number marking on device in decimal code.
  5UY **=>** **12345**
  5 x 47^2 + **27 (=U)** x 47^1 + **31 (=Y)** x 47^0 **=** **12345**

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

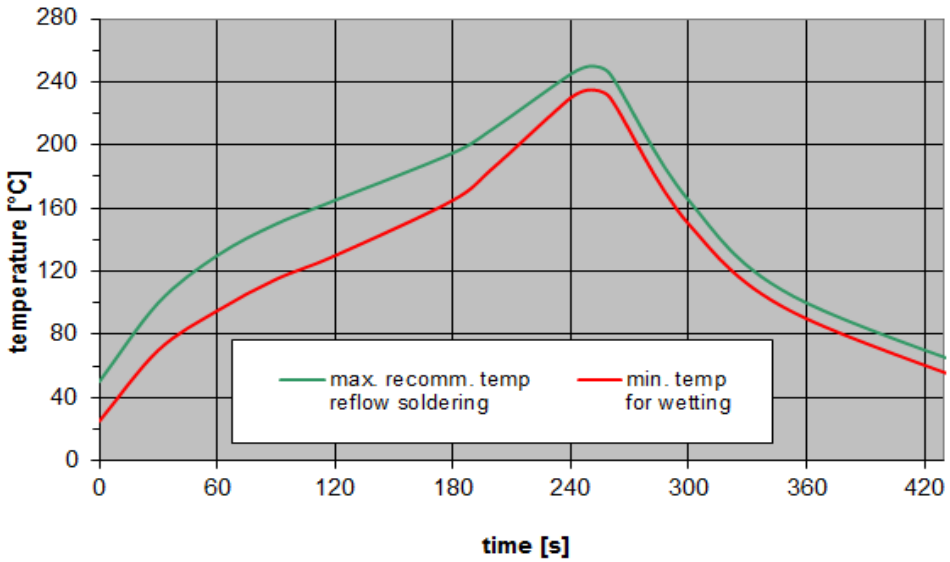

Figure 17: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

13.2 Power Transfer Function (PTF) of WCDMA signal

Attenuation of WCDMA signal, α_{WCDMA}, is defined by

$$\alpha_{\mathrm{WCDMA}}(f_{\mathrm{carrier}}) = 10\log_{10}\left|\frac{1}{\mathrm{PTF}(f_{\mathrm{carrier}})}\right| \mathrm{dB}$$

and

$$\mathrm{PTF}(f_{\mathrm{carrier}}) = \int_{-\infty}^{+\infty} \left|S_{21}(f)\, H_{\mathrm{RRC}}(f - f_{\mathrm{carrier}})\right|^2 \mathrm{d}\, f$$

with $f_{carrier}$ according to 3GPP TS 25.101 (e.g., for the WCDMA B8 pass band, $f_{carrier}$ ranges from 882.4 MHz to 912.6 MHz which correspond to the lowest and highest TX channels, respectively). $H_{RRC}(f)$ is the transfer function of the root-raised cosine transmit pulse shaping filter according to 3GPP TS 25.101 using the normalization

$$\int_{-\infty}^{+\infty} \left|H_{\mathrm{RRC}}(f)\right|^2 \mathrm{d}\, f = 1 \quad .$$

13.3 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.4 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.5 Ordering codes and packing units

Ordering code	Packing unit
B39941B8664P810	15000 pcs
B39941B8664P810S 5	5000 pcs

Table 4: Ordering codes and packing units.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available.
   The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.